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Low-power dual PCB configurable multiple function gate

Rev. 2 — 2 December 2015

Product data sheet

1. General description

The 74AUP2G98 is a dual configurable multiple function gate with Schmitt-trigger inputs. Each gate within the device can be configured as any of the following logic functions MUX, AND, OR, NAND, NOR, inverter and buffer; using the 3-bit input. All inputs can be connected directly to V_{CC} or GND.

This device ensures very low static and dynamic power consumption across the entire V_{CC} range from 0.8 V to 3.6 V.

This device is fully specified for partial power down applications using I_{OFF} . The I_{OFF} circuitry disables the output, preventing the potentially damaging backflow current through the device when it is powered down.

2. Features and benefits

- Wide supply voltage range from 0.8 V to 3.6 V
- High noise immunity
- ESD protection:
 - HBM JESD22-A114F exceeds 5000 V
 - MM JESD22-A115-A exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Low static power consumption; I_{CC} = 0.9 μA (maximum)
- Latch-up performance exceeds 100 mA per JESD 78 Class II
- Inputs accept voltages up to 3.6 V
- Low noise overshoot and undershoot < 10 % of V_{CC}
- I_{OFF} circuitry provides partial power-down mode operation
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



3. Ordering information

Table 1.Ordering information

Type number	Package							
	Temperature range	emperature range Name Description Ve						
74AUP2G98DP	–40 °C to +125 °C	TSSOP10	plastic thin shrink small outline package; 10 leads; body width 3 mm	SOT552-1				
74AUP2G98GU	–40 °C to +125 °C	XQFN10	plastic, extremely thin quad flat package; no leads; 10 terminals; body $1.40 \times 1.80 \times 0.50$ mm	SOT1160-1				
74AUP2G98GF	–40 °C to +125 °C	XSON10	plastic extremely thin small outline package; no leads; 10 terminals; body $1.0 \times 1.7 \times 0.5$ mm	SOT1081-2				

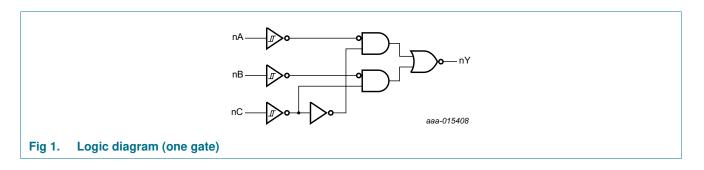
4. Marking

Table 2. Marking

Type number	Marking code ^[1]
74AUP2G98DP	a9
74AUP2G98GU	a9
74AUP2G98GF	a9

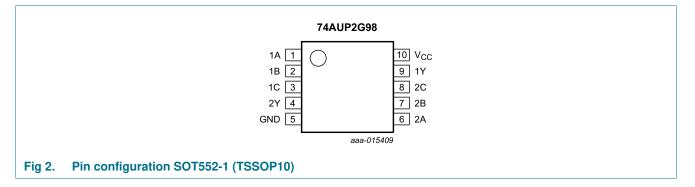
[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

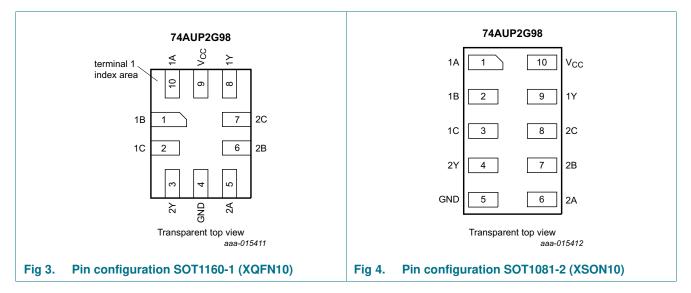
5. Functional diagram



6. Pinning information

6.1 Pinning





6.2 Pin description

Table 3. Pin description

Symbol	Pin		Description	
	SOT552-1 and SOT1081-2 SOT1160-1			
1A, 2A	1, 6	10, 5	data input	
1B, 2B	2, 7	1, 6	data input	
1C, 2C	3, 8	2, 7	data input	
1Y, 2Y	9, 4	8, 3	data output	
GND	5	4	ground (0 V)	
V _{CC}	10	9	supply voltage	

7. Functional description

Table 4. Function table^[1]

Input			Output
nC	nB n		nY
L	L	L	Н
L	L	Н	Н
L	Н	L	L
L	Н	Н	L
Н	L	L	Н
Н	L	Н	L
Н	Н	L	Н
Н	Н	Н	L

[1] H = HIGH voltage level; L = LOW voltage level.

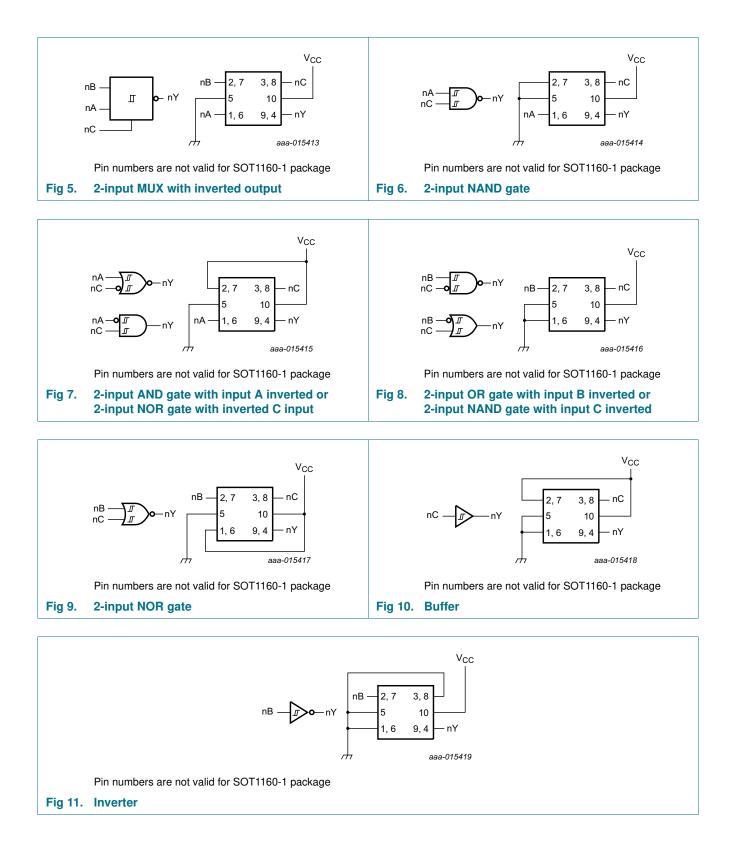
7.1 Logic configurations

Table 5.Function selection table

Logic function	Figure
2-input MUX with inverted output	see Figure 5
2-input NAND	see Figure 6
2-input NOR with one input inverted	see Figure 7
2-input AND with one input inverted	see Figure 7
2-input NAND with one input inverted	see Figure 8
2-input OR with one input inverted	see Figure 8
2-input NOR	see Figure 9
Buffer	see Figure 10
Inverter	see Figure 11

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8. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+4.6	V
I _{IK}	input clamping current	V ₁ < 0 V	-50	-	mA
VI	input voltage	<u>[1]</u>	-0.5	+4.6	V
Ι _{ΟΚ}	output clamping current	V _O < 0 V	-50	-	mA
Vo	output voltage	Active mode and Power-down ^[1] mode	-0.5	+4.6	V
lo	output current	$V_{O} = 0 V$ to V_{CC}	-	±20	mA
I _{CC}	supply current		-	50	mA
I _{GND}	ground current		-50	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$ [2]	-	250	mW

[1] The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For TSSOP10 package: above 125°C the value of P_{tot} derates linearly with 8.33 mW/K. For XQFN10 (SOT1160-1) package: above 128 °C the value of P_{tot} derates linearly with 11.5 mW/K. For XSON10 package: above 45 °C the value of P_{tot} derates linearly with 2.4 mW/K.

9. Recommended operating conditions

Table 7. Recommended operating conditions

Symbol	Parameter Conditions supply voltage input voltage output voltage Active mode Power-down mode; V _{CC} = 0 V			Max	Unit
V _{CC}	supply voltage		0.8	3.6	V
VI	input voltage		0	3.6	V
Vo	output voltage	Active mode	0	V _{CC}	V
		Power-down mode; $V_{CC} = 0 V$	0	3.6	V
T _{amb}	ambient temperature		-40	+125	°C

10. Static characteristics

Table 8. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = 2	5 °C		1	1		_
V _{OH}	HIGH-level output voltage	$V_{I} = V_{T+}$ or V_{T-}				
		I_O = –20 $\mu A; V_{CC}$ = 0.8 V to 3.6 V	$V_{CC}-0.1$	-	-	V
		$I_{O} = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$	$0.75 \times V_{CC}$	-	-	V
		$I_{O} = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	1.11	-	-	V
		$I_{O} = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.32	-	-	V
		$I_{O} = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	2.05	-	-	V
		$I_{O} = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.9	-	-	V
		$I_{O} = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.72	-	-	V
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.6	-	-	V
V _{OL}	LOW-level output voltage	$V_{I} = V_{T+} \text{ or } V_{T-}$				
		I_O = 20 $\mu A;V_{CC}$ = 0.8 V to 3.6 V	-	-	0.1	V
		$I_{O} = 1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$	-	-	$0.3 \times V_{CC}$	V
		$I_{O} = 1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	-	-	0.31	V
		$I_{O} = 1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.31	V
		I_{O} = 2.3 mA; V_{CC} = 2.3 V	-	-	0.31	V
		$I_{O} = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.44	V
		$I_{O} = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.31	V
		$I_{O} = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.44	V
lı –	input leakage current	$V_I = GND$ to 3.6 V; $V_{CC} = 0$ V to 3.6 V	-	-	±0.1	μA
I _{OFF}	power-off leakage current	V_I or $V_O = 0$ V to 3.6 V; $V_{CC} = 0$ V	-	-	±0.2	μA
ΔI_{OFF}	additional power-off leakage current		-	-	±0.2	μA
I _{CC}	supply current	$\label{eq:VI} \begin{array}{l} V_{I}=GND \text{ or } V_{CC}; \ I_{O}=0 \ \text{A}; \\ V_{CC}=0.8 \ \text{V to } 3.6 \ \text{V} \end{array}$	-	-	0.5	μ A
Δl _{CC}	additional supply current		-	-	40	μA
CI	input capacitance	$V_{CC} = 0$ V to 3.6 V; $V_I = GND$ or V_{CC}	-	1.1	-	pF
Co	output capacitance	$V_O = GND; V_{CC} = 0 V$	-	1.7	-	pF

Low-power dual PCB configurable multiple function gate

Table 8. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = -	40 °C to +85 °C					
V _{OH}	HIGH-level output voltage	$V_{I} = V_{T+}$ or V_{T-}				
		I_O = –20 $\mu A;V_{CC}$ = 0.8 V to 3.6 V	$V_{CC}-0.1$	-	-	V
		$I_{O} = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$	$0.7\times V_{CC}$	-	-	V
		$I_{O} = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	1.03	-	-	V
		$I_{O} = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.30	-	-	V
		$I_{O} = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.97	-	-	V
		$I_{O} = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.85	-	-	V
		$I_{O} = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.67	-	-	V
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.55	-	-	V
V _{OL}	LOW-level output voltage	$V_{I} = V_{T+}$ or V_{T-}				
		I_O = 20 $\mu\text{A};V_{CC}$ = 0.8 V to 3.6 V	-	-	0.1	V
		$I_{O} = 1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$	-	-	$0.3 \times V_{CC}$	V
		$I_{O} = 1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	-	-	0.37	V
		I _O = 1.9 mA; V _{CC} = 1.65 V	-	-	0.35	V
		$I_{O} = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.33	V
		$I_{O} = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.45	V
		$I_{O} = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.33	V
		$I_{O} = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.45	V
l _l	input leakage current	$V_{I} = GND$ to 3.6 V; $V_{CC} = 0$ V to 3.6 V	-	-	±0.5	μA
I _{OFF}	power-off leakage current	$V_1 \text{ or } V_0 = 0 \text{ V to } 3.6 \text{ V}; V_{CC} = 0 \text{ V}$	-	-	±0.5	μA
ΔI_{OFF}	additional power-off leakage current	$V_{I} \text{ or } V_{O} = 0 \text{ V to } 3.6 \text{ V};$ $V_{CC} = 0 \text{ V to } 0.2 \text{ V}$	-	-	±0.6	μA
I _{CC}	supply current	$\label{eq:VI} \begin{array}{l} V_{I} = GND \text{ or } V_{CC}; \ I_{O} = 0 \ A; \\ V_{CC} = 0.8 \ V \ to \ 3.6 \ V \end{array}$	-	-	0.9	μA
Δl _{CC}	additional supply current		-	-	50	μA

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Table 8. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = –	40 °C to +125 °C					-1
V _{OH}	HIGH-level output voltage	$V_{I} = V_{T+}$ or V_{T-}				
		I_O = –20 $\mu A; V_{CC}$ = 0.8 V to 3.6 V	$V_{CC}-0.11$	-	-	V
		$I_{O} = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$	$0.6 \times V_{CC}$	-	-	V
		$I_{O} = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	0.93	-	-	V
		$I_{O} = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.17	-	-	V
		$I_{O} = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.77	-	-	V
		$I_{O} = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.67	-	-	V
		$I_{O} = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.40	-	-	V
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.30	-	-	V
V _{OL}	LOW-level output voltage	$V_{I} = V_{T+}$ or V_{T-}				
		I_O = 20 $\mu A;V_{CC}$ = 0.8 V to 3.6 V	-	-	0.11	V
		I _O = 1.1 mA; V _{CC} = 1.1 V	-	-	$0.33 \times V_{CC}$	V
		I _O = 1.7 mA; V _{CC} = 1.4 V	-	-	0.41	V
		I _O = 1.9 mA; V _{CC} = 1.65 V	-	-	0.39	V
		$I_{O} = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.36	V
		$I_{O} = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.50	V
		$I_{O} = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.36	V
		$I_{O} = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.50	V
I _I	input leakage current	$V_I = GND$ to 3.6 V; $V_{CC} = 0$ V to 3.6 V	-	-	±0.75	μA
I _{OFF}	power-off leakage current	$V_1 \text{ or } V_0 = 0 \text{ V to } 3.6 \text{ V}; V_{CC} = 0 \text{ V}$	-	-	±0.75	μA
ΔI_{OFF}	additional power-off leakage current	$V_{I} \text{ or } V_{O} = 0 \text{ V to } 3.6 \text{ V};$ $V_{CC} = 0 \text{ V to } 0.2 \text{ V}$	-	-	±0.75	μA
I _{CC}	supply current	$\label{eq:VI} \begin{array}{l} V_{I}=GND \text{ or } V_{CC}; \ I_{O}=0 \ A; \\ V_{CC}=0.8 \ V \ to \ 3.6 \ V \end{array}$	-	-	1.4	μA
Δl _{CC}	additional supply current		-	-	75	μA

[1] One input at V_{CC} – 0.6 V, other input at V_{CC} or GND.

11. Dynamic characteristics

Table 9. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit, see Figure 13.

Symbol	Parameter	Conditions	T _{amb} = 25 °C			$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$			
				Typ[1]	Max	Min	Max (85 °C)	Max (125 °C)	
C _L = 5 pl	F								-
t _{pd}	propagation delay	nA, nB, nC to nY; see Figure 12 [2]							
		V _{CC} = 0.8 V	-	23.3	-	-	-	-	ns
		V _{CC} = 1.1 V to 1.3 V	2.9	6.7	12.9	2.7	13.2	13.4	ns
		V _{CC} = 1.4 V to 1.6 V	2.4	4.8	7.7	2.4	8.3	8.7	ns
		V _{CC} = 1.65 V to 1.95 V	2.2	4.0	6.3	1.9	7.0	7.4	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	2.0	3.2	4.6	1.8	5.2	5.4	ns
		V _{CC} = 3.0 V to 3.6 V	1.9	2.9	4.0	1.6	4.2	4.4	ns
C _L = 10 p	pF								
t _{pd}	propagation delay	nA, nB, nC to nY; see Figure 12 [2]							
		V _{CC} = 0.8 V	-	27.1	-	-	-	-	ns
		V _{CC} = 1.1 V to 1.3 V	3.3	7.6	14.5	3.0	15.1	15.3	ns
		V _{CC} = 1.4 V to 1.6 V	2.7	5.4	8.8	2.8	9.5	9.9	ns
		V _{CC} = 1.65 V to 1.95 V	2.5	4.6	7.2	2.3	8.0	8.4	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	2.4	3.8	5.3	2.2	5.9	6.2	ns
		V _{CC} = 3.0 V to 3.6 V	2.3	3.5	4.7	2.0	4.9	5.2	ns
C _L = 15 p	pF								
t _{pd}	propagation delay	nA, nB, nC to nY; see Figure 12 [2]							
		V _{CC} = 0.8 V	-	30.6	-	-	-	-	ns
		V _{CC} = 1.1 V to 1.3 V	3.6	8.4	16.1	3.3	16.9	17.2	ns
		V _{CC} = 1.4 V to 1.6 V	3.0	6.0	9.7	3.1	10.5	11.0	ns
		V _{CC} = 1.65 V to 1.95 V	2.8	5.1	7.9	2.5	8.9	9.3	ns
		$V_{CC} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$	2.7	4.2	5.9	2.5	6.6	7.0	ns
		V _{CC} = 3.0 V to 3.6 V	2.5	3.9	5.2	2.2	5.5	5.8	ns
C _L = 30 p	pF								
t _{pd}	propagation delay	nA, nB, nC to nY; see Figure 12 [2]							
		V _{CC} = 0.8 V	-	38.7	-	-	-	-	ns
		V _{CC} = 1.1 V to 1.3 V	4.5	10.7	21.1	4.1	22.0	22.4	ns
		V _{CC} = 1.4 V to 1.6 V	3.8	7.6	12.3	3.8	13.5	14.2	ns
		V _{CC} = 1.65 V to 1.95 V	3.5	6.3	10.1	3.1	11.3	11.9	ns
		V _{CC} = 2.3 V to 2.7 V	3.4	5.3	7.5	3.2	8.4	8.9	ns
		V _{CC} = 3.0 V to 3.6 V	3.2	5.0	6.7	2.9	7.1	7.5	ns

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Low-power dual PCB configurable multiple function gate

Table 9. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V); for test circuit, see <u>Figure 13</u>.

Symbol	Parameter	Conditions		T _{amb} = 25 °C			T _{amb} = -40 °C to +125 °C			
				Typ <mark>[1]</mark>	Max	Min	Max (85 °C)	Max (125 °C)	-	
C _L = 5 pl	F, 10 pF, 15 pF and	30 pF								
C _{PD}	power dissipation	$f_i = 1 \text{ MHz}; V_I = \text{GND to } V_{\text{CC}}$ [3]								
	capacitance	V _{CC} = 0.8 V	-	2.7	-	-	-	-	pF	
		V _{CC} = 1.1 V to 1.3 V	-	2.9	-	-	-	-	pF	
		V _{CC} = 1.4 V to 1.6 V	-	3.0	-	-	-	-	pF	
		V _{CC} = 1.65 V to 1.95 V	-	3.2	-	-	-	-	pF	
		V _{CC} = 2.3 V to 2.7 V	-	3.8	-	-	-	-	pF	
		V _{CC} = 3.0 V to 3.6 V	-	4.4	-	-	-	-	pF	

[1] All typical values are measured at nominal V_{CC} .

[2] t_{pd} is the same as t_{PLH} and t_{PHL}

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where:

 f_i = input frequency in MHz;

 $f_o = output frequency in MHz;$

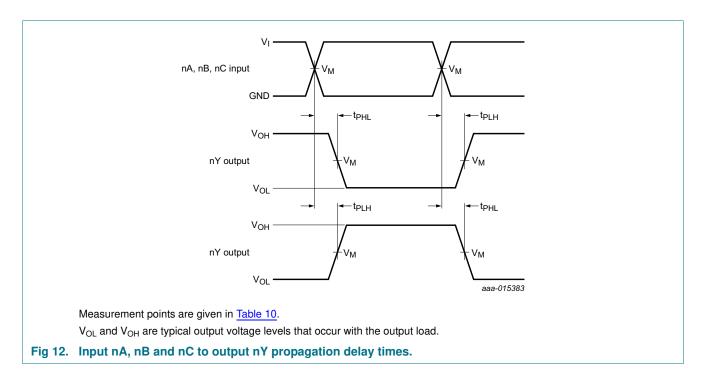
 C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_0)$ = sum of the outputs.

12. Waveforms



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74AUP2G98

Low-power dual PCB configurable multiple function gate

Table 10.Measurement points

Supply voltage	Output	Input		
V _{CC}	V _M	V _M	VI	t _r = t _f
0.8 V to 3.6 V	0.5V _{CC}	$0.5\times V_{CC}$	$0.5\times V_{CC}$	≤ 3.0 ns

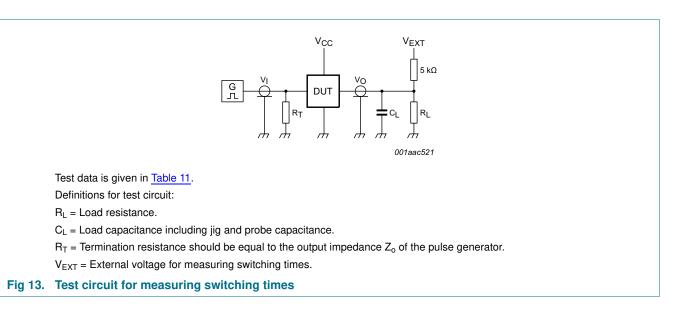


Table 11. Test data

Supply voltage	Load		V _{EXT}		
V _{cc}	CL	R _L [1]	t _{PLH} , t _{PHL}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}
0.8 V to 3.6 V	5 pF, 10 pF, 15 pF and 30 pF	5 k Ω or 1 M Ω	open	GND	2V _{CC}

[1] For measuring enable and disable times, $R_L = 5 \text{ k}\Omega$, for measuring propagation delays, setup and hold times and pulse width $R_L = 1 M\Omega$.

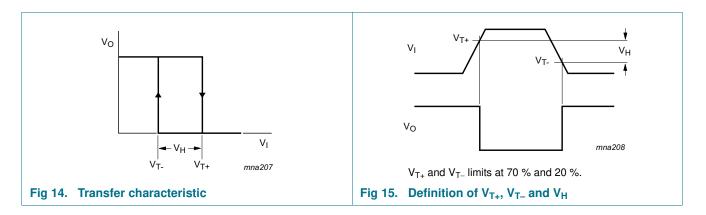
13. Transfer characteristics

Table 12. Transfer characteristics

Voltages are referenced to GND (ground = 0 V; for test circuit, see Figure 13.

Symbol	Parameter	Conditions	Tan	T _{amb} = 25 °C		T _{amb} = -40 °C to +125 °C		Unit	
			Min	Тур	Max	Min	Max (85 °C)	Max (125 °C)	
V _{T+} positive-going		see Figure 14 and Figure 15							
	threshold voltage	V _{CC} = 0.8 V	0.30	-	0.60	0.30	0.60	0.62	V
		$V_{CC} = 1.1 V$	0.53	-	0.90	0.53	0.90	0.92	V
		V _{CC} = 1.4 V	0.74	-	1.11	0.74	1.11	1.13	V
		V _{CC} = 1.65 V	0.91	-	1.29	0.91	1.29	1.31	V
		V _{CC} = 2.3 V	1.37	-	1.77	1.37	1.77	1.80	V
		V _{CC} = 3.0 V	1.88	-	2.29	1.88	2.29	2.32	V
V_{T-}	negative-going	see Figure 14 and Figure 15							
	threshold voltage	V _{CC} = 0.8 V	0.10	-	0.60	0.10	0.60	0.60	V
		V _{CC} = 1.1 V	0.26	-	0.65	0.26	0.65	0.65	V
		V _{CC} = 1.4 V	0.39	-	0.75	0.39	0.75	0.75	V
		V _{CC} = 1.65 V	0.47	-	0.84	0.47	0.84	0.84	V
	V _{CC} = 2.3 V	0.69	-	1.04	0.69	1.04	1.04	V	
		V _{CC} = 3.0 V	0.88	-	1.24	0.88	1.24	1.24	V
V _H	hysteresis	$(V_{T_{+}} - V_{T_{-}})$; see Figure 14, Figure 15, Figure 16 and Figure 17							
	voltage	$V_{CC} = 0.8 V$	0.07	-	0.50	0.07	0.50	0.50	V
		$V_{CC} = 1.1 V$	0.08	-	0.46	0.08	0.46	0.46	V
	$V_{CC} = 1.4 V$	0.18	-	0.56	0.18	0.56	0.56	V	
		V _{CC} = 1.65 V	0.27	-	0.66	0.27	0.66	0.66	V
		V _{CC} = 2.3 V	0.53	-	0.92	0.53	0.92	0.92	V
	V _{CC} = 3.0 V	0.79	-	1.31	0.79	1.31	1.31	V	

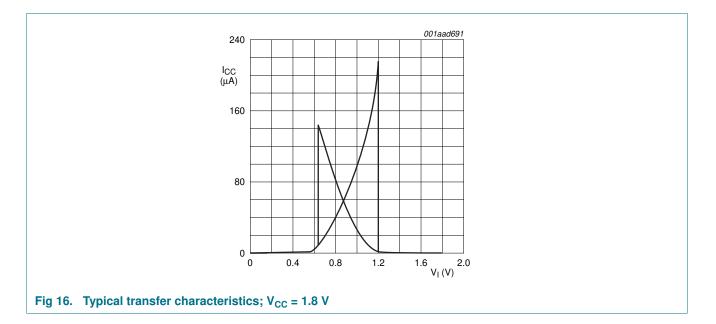
14. Waveforms transfer characteristics

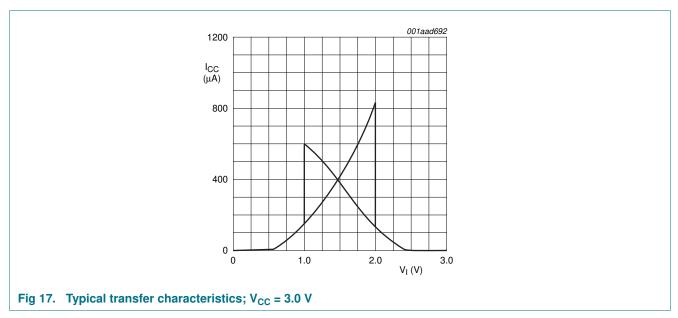


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15. Package outline

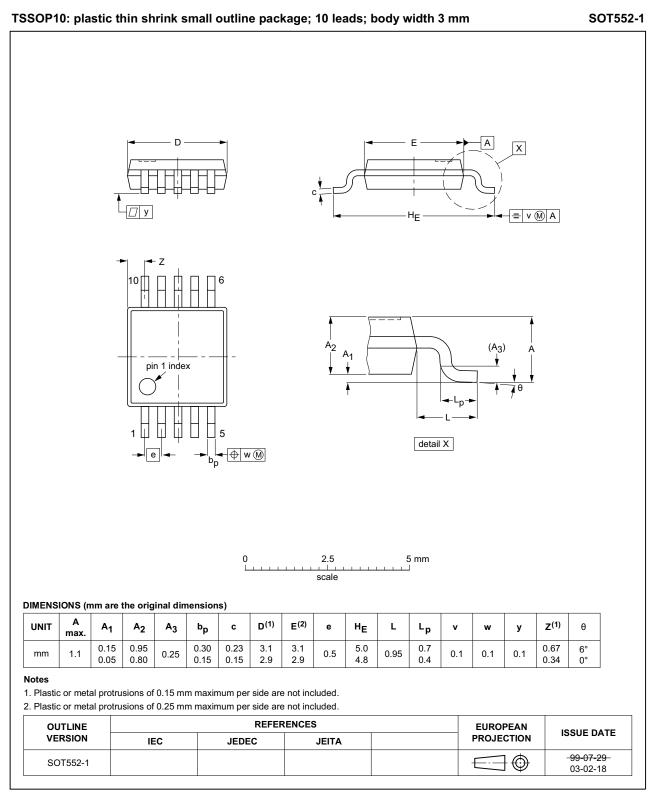
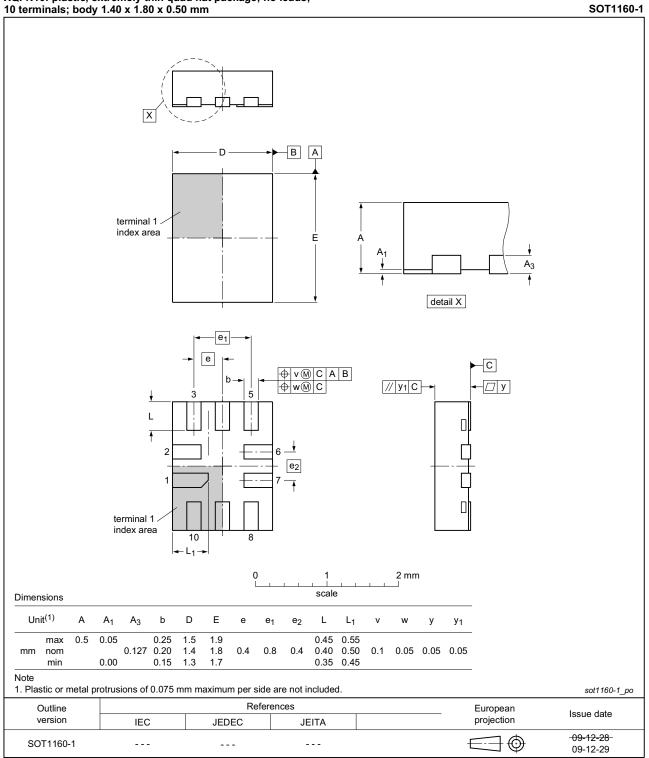


Fig 18. Package outline SOT552-1 (TSSOP10)

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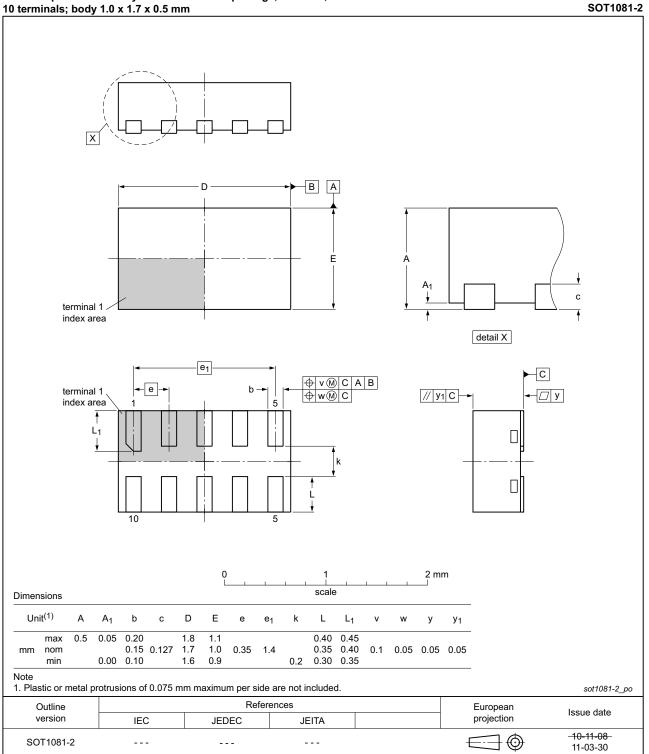


XQFN10: plastic, extremely thin quad flat package; no leads; 10 terminals; body 1.40 x 1.80 x 0.50 mm

Fig 19. Package outline SOT1160-1 (XQFN10)

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XSON10: plastic extremely thin small outline package; no leads;

Fig 20. Package outline SOT1081-2 (XSON10)

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16. Abbreviations

Table 13. Abbreviations			
Acronym	Description		
CDM	Charged Device Model		
DUT	Device Under Test		
ESD	ElectroStatic Discharge		
HBM	Human Body Model		
MM	Machine Model		
РСВ	Printed-Circuit Board		

17. Revision history

Table 14. Revision history				
Document ID	Release date	Data sheet status	Change notice	Supersedes
74AUP2G98 v.2	20151202	Product data sheet	-	74AUP2G98 v.1
Modifications:	• Maximum value temperature range TSSOP10 (74AUP2G98DP) changed from 85 °C to 125 °C.			
	Removed 74AU	P2G98GM (SOT1049-3).		
74AUP2G98 v.1	20141104	Product data sheet	-	-

18. Legal information

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Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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[2] The term 'short data sheet' is explained in section "Definitions".

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